.05-14-0

Case Docket No. ADTST.029AUS Date: May 12, 2001

Page 1

## ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

ATTENTION: APPLICATION BRANCH

Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): Rochit Rajsuman

For: METHOD OF EVALUATING CORE BASED SYSTEM-ON-A-CHIP (SOC) AND STRUCTURE OF

SOC INCORPORATING SAME

Enclosed are:

(X) 6 sheet(s) of drawings.

(X) 13 pages of specification, claims and abstract.

(X) UNSIGNED declaration and power of attorney.

(X) Return prepaid postcard.

CLAIMS AS FILED				
FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$710	\$710
Total Claims	9 - 20 =	0 ×	\$18	\$0
Independent Claims	3 - 3 =	0 ×	\$80	\$0
If application contains any multiple dependent claims(s), then add \$270				\$0
	TOTAL FILING FEE			\$710

(X) A check in the amount of \$710 to cover the filing fee is enclosed.

SEND ALL CORRESPONDENCE TO:

**MURAMATSU & ASSOCIATES** 7700 Irvine Center Drive

Suite 225

Irvine, CA 92618 Tel: (949) 753-1127

Yasuo Muramatsu

Printed Name

38,684

Registration Number

law offices of

## Muramatsu & Associates

7700 Irvine Center Drive, Suite 225 Irvine, CA 92618, U.S.A.

> Tel (949) 753-1127 Fax (949) 753-1071 E-mail: muramat@ix.netcom.com

> > May 12, 2001

Assistant Commissioner for Patents Washington, D.C. 20231

## CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Attorney Docket No.

ADTST.029AUS

Applicant(s)

Rochit Rajsuman

For

: **BASED** 

METHOD OF **EVALUATING CORE** 

SYSTEM-ON-A-CHIP (SOC) AND STRUCTURE OF SOC INCORPORATING

**SAME** 

**Attorney** 

Yasuo Muramatsu

"Express Mail"

Mailing Label No.

EL740911857US

**Date of Deposit** 

May 12, 2001

I hereby certify that the accompanying

Transmittal; a patent application in 13 pages of specification and 6 sheets of drawings; a check of \$710 for filing fee; unsigned declaration and power of attorney: Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

Jasuo Muramatsu

XPR-AD29.001 051101